



74HC1G08; 74HCT1G08

2-input AND gate

Rev. 9 — 23 September 2024

Product data sheet

1. General description

The 74HC1G08; 74HCT1G08 is a single 2-input AND gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

2. Features and benefits

- Wide supply voltage range from 2.0 V to 6.0 V
- CMOS low power dissipation
- High noise immunity
- Symmetrical output impedance
- Balanced propagation delays
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Input levels:
 - For 74HC1G08: CMOS level
 - For 74HCT1G08: TTL level
- Complies with JEDEC standards:
 - JESD8C (2.7 V to 3.6 V)
 - JESD7A (2.0 V to 6.0 V)
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40°C to $+85^{\circ}\text{C}$ and -40°C to $+125^{\circ}\text{C}$

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC1G08GW 74HCT1G08GW	-40°C to $+125^{\circ}\text{C}$	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74HC1G08GV 74HCT1G08GV	-40°C to $+125^{\circ}\text{C}$	SC-74A	plastic surface-mounted package; 5 leads	SOT753
74HC1G08GZ 74HCT1G08GZ	-40°C to $+125^{\circ}\text{C}$	XSON5	plastic thermal enhanced extremely thin small outline package with side-wettable flanks (SWF); no leads; 5 terminals; body $1.1 \times 0.85 \times 0.5$ mm	SOT8065-1

4. Marking

Table 2. Marking codes

Type number	Marking ^[1]
74HC1G08GW	HE
74HCT1G08GW	TE
74HC1G08GV	H08
74HCT1G08GV	T08
74HC1G08GZ	HE
74HCT1G08GZ	TE

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

mna113

Fig. 1. Logic symbol

mna114

Fig. 2. IEC logic symbol

mna115

Fig. 3. Logic diagram

6. Pinning information

6.1. Pinning

GW package
SOT353-1 (TSSOP5)

aaa-035731

GV package
SOT753 (SC-74A)

aaa-035732

GZ package
SOT8065-1 (XSON5)

aaa-035935

Transparent top view

6.2. Pin description

Table 3. Pin description

Symbol	Pin	Description
B	1	data input
A	2	data input
GND	3	ground (0 V)
Y	4	data output
V _{CC}	5	supply voltage

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level.

Input		Output
A	B	Y
L	L	L
L	H	L
H	L	L
H	H	H

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V). [1]

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
I _{IK}	input clamping current	V _I < -0.5 V or V _I > V _{CC} + 0.5 V	-	±20	mA
I _{OK}	output clamping current	V _O < -0.5 V or V _O > V _{CC} + 0.5 V	-	±20	mA
I _O	output current	-0.5 V < V _O < V _{CC} + 0.5 V	-	±12.5	mA
I _{CC}	supply current		-	25	mA
I _{GND}	ground current		-25	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C [2]	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
[2] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C.
For SOT8065-1 (XSON5) package: P_{tot} derates linearly with 3.2 mW/K above 72 °C.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	74HC1G08			74HCT1G08			Unit
			Min	Typ	Max	Min	Typ	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
V _I	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
V _O	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	-	139	-	-	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

10. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V). All typical values are measured at T_{amb} = 25 °C.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	
74HC1G08								
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	V
		V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	V
		V _{CC} = 4.5 V						

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	
74HCT1G08								
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}						
		I _O = -20 µA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	V
		I _O = -2.0 mA; V _{CC} = 4.5 V	4.13	4.32	-	3.7	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}						
		I _O = 20 µA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	V
		I _O = 2.0 mA; V _{CC} = 4.5 V	-	0.15	0.33	-	0.4	V
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 5.5 V	-	-	1.0	-	1.0	µA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	10	-	20	µA
ΔI _{CC}	additional supply current	per input; V _{CC} = 4.5 V to 5.5 V; V _I = V _{CC} - 2.1 V; I _O = 0 A	-	-	500	-	850	µA
C _I	input capacitance		-	1.5	-	-	-	pF

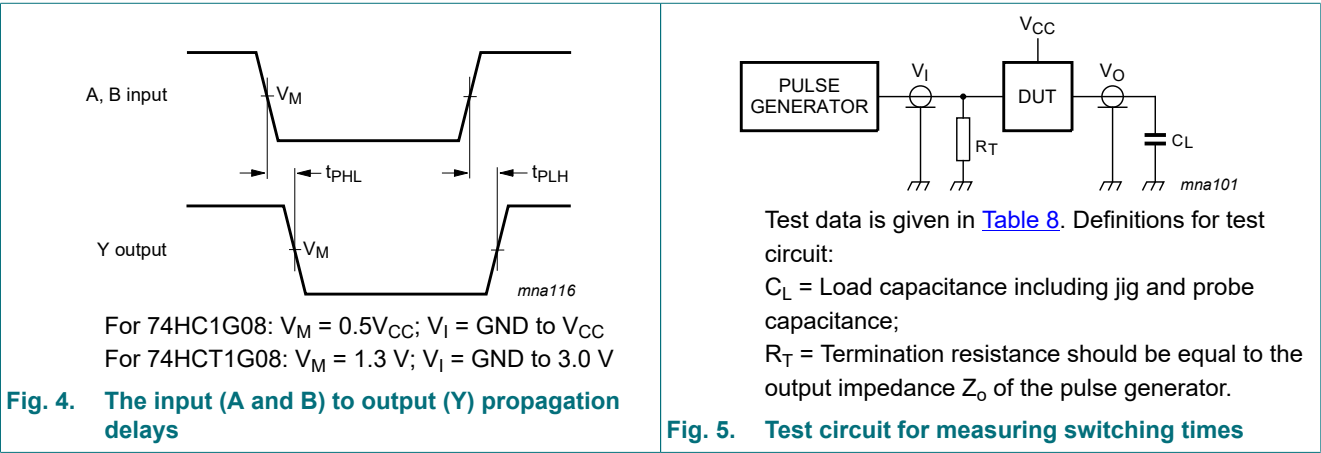
11. Dynamic characteristics

Table 8. Dynamic characteristics

GND = 0 V; t_r = t_f ≤ 6.0 ns; All typical values are measured at T_{amb} = 25 °C. For test circuit see Fig. 5.

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ	Max</			

11.1. Waveform and test circuit



12. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1

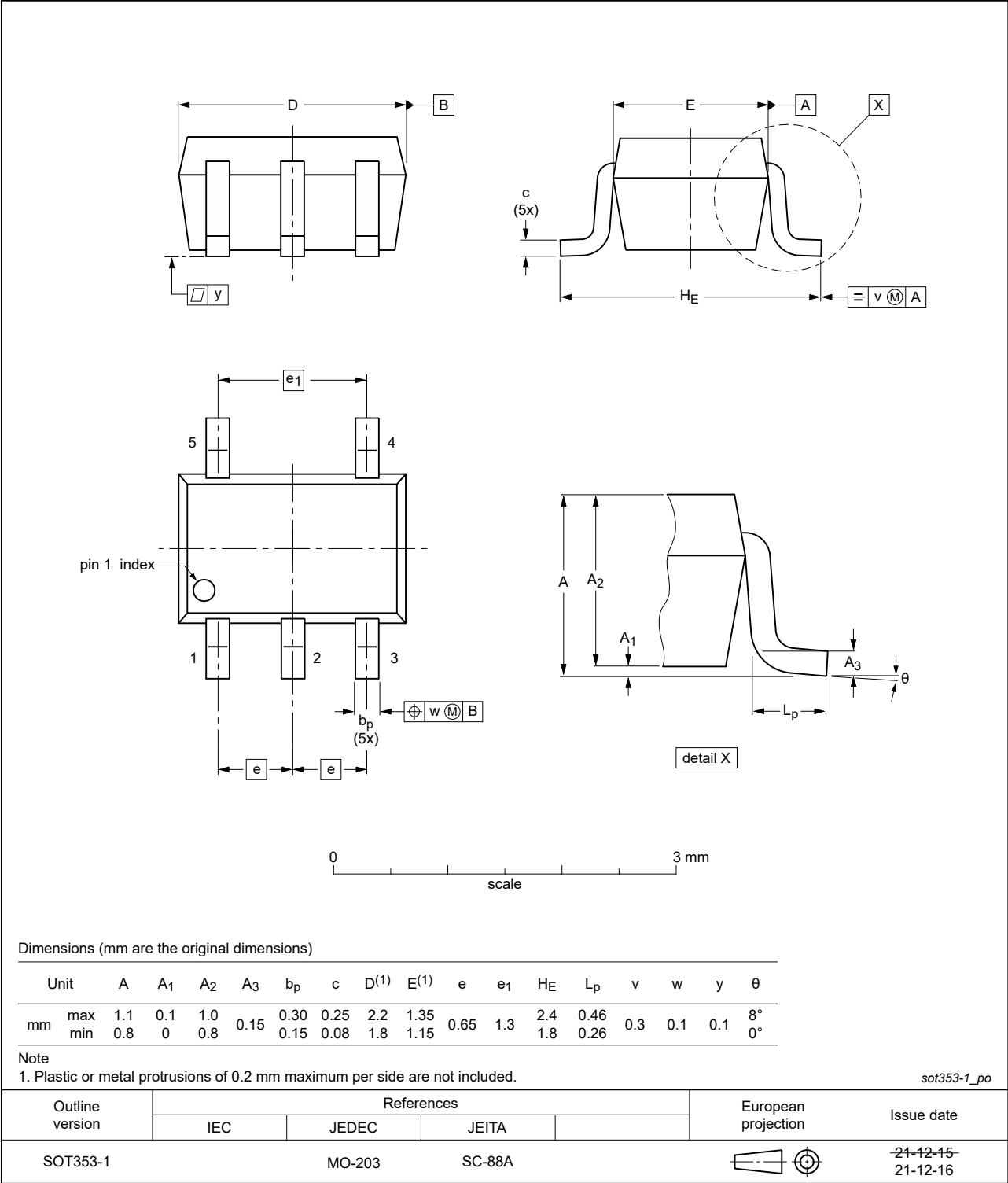


Fig. 6. Package outline SOT353-1 (TSSOP5)

Plastic surface-mounted package; 5 leads

SOT753

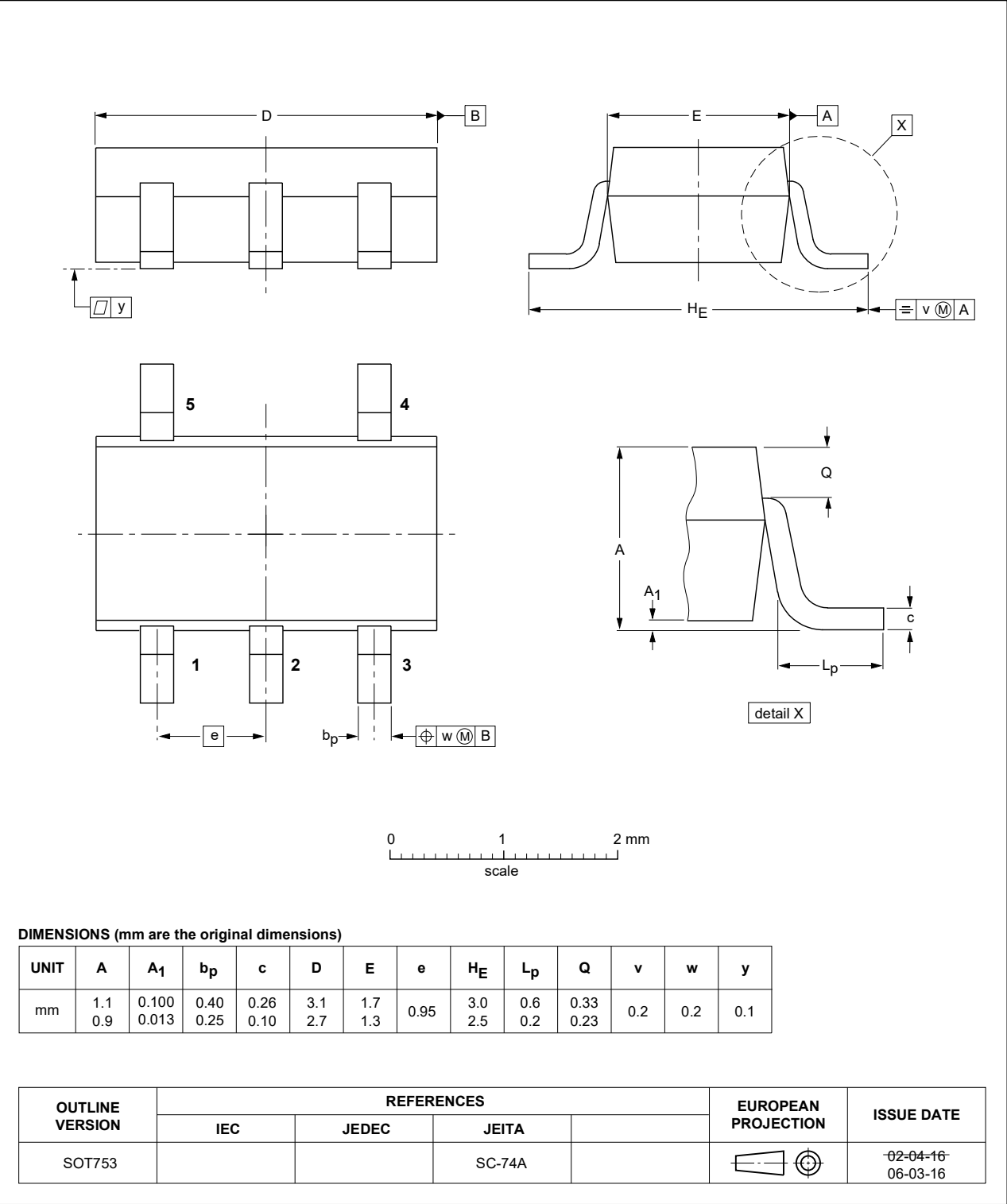


Fig. 7. Package outline SOT753 (SC-74A)

XSON5: Plastic thermal enhanced extremely thin small outline package with side-wettable flanks (SWF); no leads; 5 terminals; body 1.1 × 0.85 × 0.5 mm

SOT8065-1

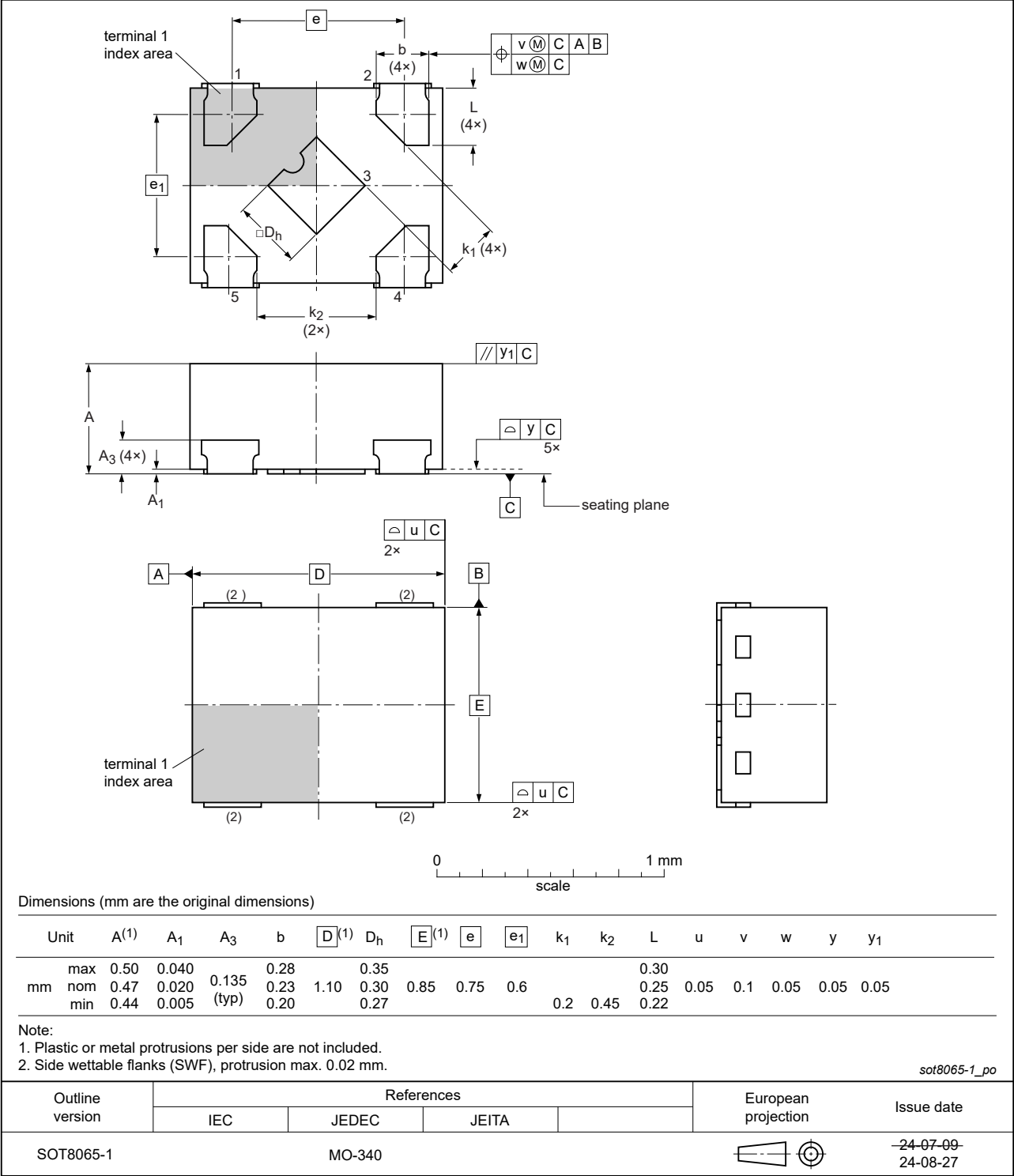


Fig. 8. Package outline SOT8065-1 (XSON5)

13. Abbreviations

Table 9. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
HBM	Human Body Model
JEDEC	Joint Electron Device Engineering Council
TTL	Transistor-Transistor Logic

14. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT1G08 v.9	20240923	Product data sheet	-	74HC_HCT1G08 v.8
Modifications:	• Type number 74HC1G08GZ (SOT8065-1/XSON5) added.			
74HC_HCT1G08 v.8.1	20240830	Product data sheet	-	74HC_HCT1G08 v.8
Modifications:	• Fig. 8 : Added JEDEC reference MO-340 to SOT8065-1 package outline drawing.			
74HC_HCT1G08 v.8	20240715	Product data sheet	-	74HC_HCT1G08 v.7
Modifications:	• Type number 74HCT1G08GZ (SOT8065-1/XSON5) added.			
74HC_HCT1G08 v.7	20240621	Product data sheet	-	74HC_HCT1G08 v.6
Modifications:	• Section 2 : ESD specification updated according to the latest JEDEC standard.			
74HC_HCT1G08 v.6	20220117	Product data sheet	-	74HC_HCT1G08 v.5
Modifications:	• Section 2 updated. • Section 8 : Derating values for P _{tot} total power dissipation updated. • Fig. 6 : Package outline drawing SOT353-1 (TSSOP5) has changed.			
74HC_HCT1G08 v.5	20180314	Product data sheet	-	74HC_HCT1G08 v.4
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate.			
74HC_HCT1G08 v.4	20070717	Product data sheet	-	74HC_HCT1G08 v.3
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Package SOT353 changed to SOT353-1 in Table 1 and Fig. 6 . • Quick Reference Data and Soldering sections removed. • Section 2 "Features" updated.			
74HC_HCT1G08 v.3	20020517	Product specification	-	74HC_HCT1G08 v.2
74HC_HCT1G08 v.2	20010302	Product specification	-	74HC_HCT1G08 v.1
74HC_HCT1G08 v.1	19981110	Preliminary specification	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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